

SL-SMT 5.08HC/11/90LF 1.5SN BK RL CO
Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com



Similar to illustration

High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

| | |
|--------------|---|
| Version | PCB plug-in connector, male header, Solder flange, THT/THR solder connection, 5.08 mm, Number of poles: 11, 90°, Solder pin length (l): 1.5 mm, tinned, black, Tape |
| Order No. | 1422980000 |
| Type | SL-SMT 5.08HC/11/90LF 1.5SN BK RL CO |
| GTIN (EAN) | 4050118227116 |
| Qty. | 300 pc(s). |
| Product data | IEC: 400 V / 27.5 A UL: 300 V / 18.5 A |
| Packaging | Tape |

Creation date March 23, 2021 10:07:09 PM CET

SL-SMT 5.08HC/11/90LF 1.5SN BK RL CO

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Dimensions and weights

| | | | |
|--------------------------|----------|-----------------|------------|
| Depth | 12 mm | Depth (inches) | 0.472 inch |
| Height | 10 mm | Height (inches) | 0.394 inch |
| Height of lowest version | 8.5 mm | Net weight | 5.252 g |
| Width | 65.68 mm | Width (inches) | 2.586 inch |

System specifications

| | | | |
|---------------------------|-------------------------------------|--------------------------------|------------------|
| Product family | OMNIMATE Signal - series BL/SL 5.08 | Type of connection | Board connection |
| Mounting onto the PCB | THT/THR solder connection | Pitch in mm (P) | 5.08 mm |
| Pitch in inches (P) | 0.2 inch | Outgoing elbow | 90° |
| Number of poles | 11 | Number of solder pins per pole | 1 |
| Solder pin length (l) | 1.5 mm | Solder pin length tolerance | 0 / -0.3 mm |
| Solder pin dimensions | d = 1.2 mm, Octagonal | L1 in mm | 50.8 mm |
| L1 in inches | 2 inch | Pin series quantity | 2 |
| Volume resistance | ≤5 mΩ | Can be coded | Yes |
| Plugging force/pole, max. | 9 N | Pulling force/pole, max. | 7 N |

Material data

| | | | |
|---------------------------------------|--------------------------------|---------------------------------------|--------------------------------|
| Insulating material | LCP GF | Colour | black |
| Colour chart (similar) | RAL 9011 | Insulating material group | Illa |
| Comparative Tracking Index (CTI) | ≥ 175 | Moisture Level (MSL) | 1 |
| UL 94 flammability rating | V-0 | Contact material | CuMg |
| Contact surface | tinned | Layer structure of solder connection | 1...3 μm Ni / 2...4 μm Sn matt |
| Layer structure of plug contact | 1...3 μm Ni / 2...4 μm Sn matt | Storage temperature, min. | -40 °C |
| Storage temperature, max. | 70 °C | Operating temperature, min. | -50 °C |
| Operating temperature, max. | 100 °C | Temperature range, installation, min. | -30 °C |
| Temperature range, installation, max. | 100 °C | | |

Rated data acc. to IEC

| | | | |
|---|------------------------|---|--------|
| tested acc. to standard | IEC 60664-1, IEC 61984 | Rated current, min. number of poles (Tu=20°C) | 27.5 A |
| Rated current, max. number of poles (Tu=20°C) | 19 A | Rated current, min. number of poles (Tu=40°C) | 24 A |
| Rated current, max. number of poles (Tu=40°C) | 16.5 A | Rated voltage for surge voltage class / pollution degree II/2 | 400 V |
| Rated voltage for surge voltage class / pollution degree III/2 | 320 V | Rated voltage for surge voltage class / pollution degree III/3 | 250 V |
| Rated impulse voltage for surge voltage class/ pollution degree II/2 | 4 kV | Rated impulse voltage for surge voltage class/ pollution degree III/2 | 4 kV |
| Rated impulse voltage for surge voltage class/ contamination degree III/3 | 4 kV | | |

Rated data acc. to CSA

| | | | |
|-----------------------------------|--------|-----------------------------------|--------|
| Rated voltage (Use group B / CSA) | 300 V | Rated voltage (Use group D / CSA) | 300 V |
| Rated current (Use group B / CSA) | 18.5 A | Rated current (Use group D / CSA) | 18.5 A |

SL-SMT 5.08HC/11/90LF 1.5SN BK RL CO

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Rated data acc. to UL 1059

Institute (UR)



Certificate No. (UR)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group B / UL 1059) 18.5 A

Rated current (Use group D / UL 1059) 10 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Packing

| | | | |
|--------------------------------------|---------|-----------------------------|-------------------------------|
| Packaging | Tape | VPE length | 95 mm |
| VPE width | 330 mm | VPE height | 330 mm |
| Tape depth (T2) | 13 mm | Tape width (W) | 88 mm |
| Tape pocket depth (K0) | 12.5 mm | Tape pocket height (A0) | 12.3 mm |
| Tape pocket width (B0) | 71.4 mm | Tape pocket separation (P1) | 16 mm |
| Tape hole separation (E) | 1.75 mm | Tape pocket separation (F) | 42.2 mm |
| Tape reel diameter \varnothing (A) | 330 mm | Surface resistance | $R_s = 10^9 - 10^{12} \Omega$ |

Classifications

| | | | |
|-------------|-------------|-------------|-------------|
| ETIM 6.0 | EC002637 | ETIM 7.0 | EC002637 |
| ECLASS 9.0 | 27-44-04-02 | ECLASS 9.1 | 27-44-04-02 |
| ECLASS 10.0 | 27-44-04-02 | ECLASS 11.0 | 27-46-02-01 |

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Gold-plated contact surfaces on request
- Rated current related to rated cross-section & min. No. of poles.
- Diameter of solder eyelet $D = 1.4 + 0.1 \text{ mm}$
- Solder eyelet diameter $D = 1.5 + 0.1 \text{ mm}$, from 9 poles
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals



ROHS Conform

UL File Number Search E60693

Creation date March 23, 2021 10:07:09 PM CET

Catalogue status 12.03.2021 / We reserve the right to make technical changes.

3

Data sheet

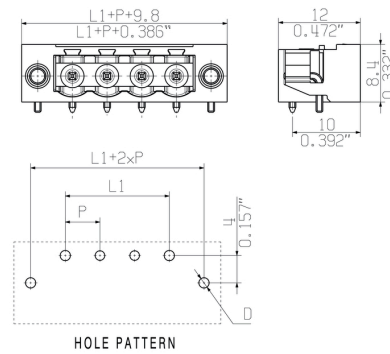
SL-SMT 5.08HC/11/90LF 1.5SN BK RL CO

Weidmüller Interface GmbH & Co. KG
 Klängenbergstraße 26
 D-32758 Detmold
 Germany

www.weidmueller.com

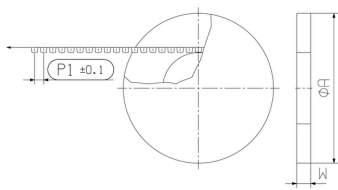
Drawings

Dimensional drawing

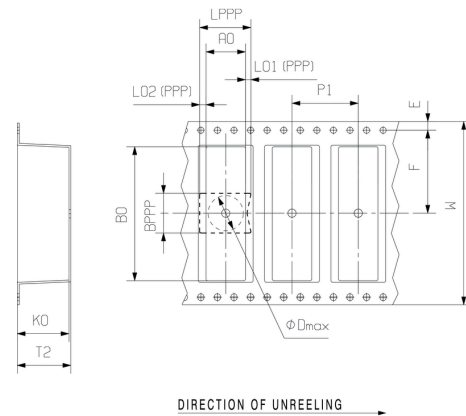


HOLE PATTERN

Dimensional drawing



Dimensional drawing

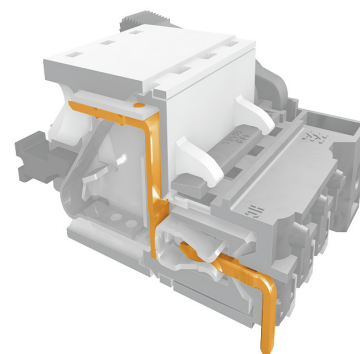


DIRECTION OF UNREELING →

Example of use



Product benefits



Safe power transmission
 Proven properties

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
 Klingenbergstraße 16
 D-32758 Detmold
 Germany
 Fon: +49 5231 14-0
 Fax: +49 5231 14-292083
 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
 Klingenbergstraße 16
 D-32758 Detmold
 Germany
 Fon: +49 5231 14-0
 Fax: +49 5231 14-292083
 www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is ‚activated‘. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.